



RoHS Compliant

Description

brick fuse for the small size and good electrical performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our brick fuses more heat and shock tolerant than typical brick fuses.

Applications

Used in notebook PC, telecom system, LCD/PDP TV, wireless goods, LCD monitor, white goods, LCD/PDP panel, game console, power supply, net working and other electronics products.

Features

- · Rapid interruption of excessive current
- Compatible with reflow and wave soldering
- · Ceramic body and silver plated copper terminal
- Excellent environmental integrity
- · One time positive disconnect
- Lead-free and Halogen-free
- Designed to UL 248-14

Specifications

Operating Temperature : -55°C to +125°C Storage Conditions : +10°C to +60°C

Relative Humidity : ≤75% yearly average without dew, maximum 30 days at 95%

Vibration Resistance : 24 cycles at 15 min. each

10-60Hz at 0.75mm amplitude 60-2000Hz at 10g acceleration

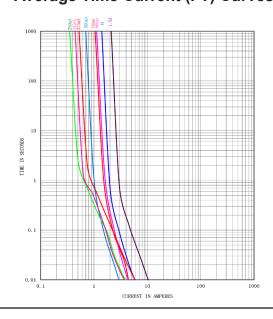
Electrical Characteristics

Time vs Current Characteristics Table

(measured with constant current power supply)

Time vs Current Characteristics					
Rated current	100%	200%			
0.25A to 1.5A	>4h	<5s			

Average Time Current (I-T) Curves



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Electrical Characteristics at 25°C

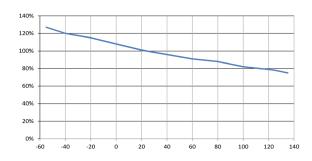
Amp Code	Rated Current	Rated Voltage DC	Typical Voltage Drop (mV)	Breaking Capacity	Typical Melting I ² T (A ² s)	Typ. Cold Resistance (mΩ)
0250	0.25A	125V AC 125V DC	300		0.144	519.4~964.6
0315	0.315A		300		0.137	361.2~670.8
0375	0.375A		300		0.335	275.1~510.9
0500	0.5A		600	100A@125V AC	0.090	520.1~965.9
0750	0.75A		500	50A@125V DC	0.160	280.7~521.3
0800	0.8A		500		0.203	238.7~443.3
1100	1A		500		0.900	172.9~321.1
1150	1.5A		350		1.069	100.8~187.2

Note:

- (1) Permissible continuous operating current is ≤100% at ambient temperature of 23°C (73.4°F).
- (2) The current values used for calculating I2T should be 8~10ms.
- (3) The product without sand when the current is no more than 0.375A.

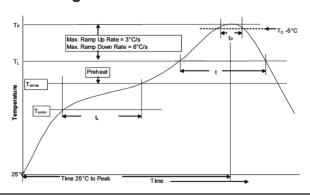
Temperature Re-rating Curve

Temperature Derating Curve



Calculation for ideal fuse selection = $\frac{\text{Operating Current (A)}}{\text{Rating (\% 0.75)}}$

Soldering Parameters



1. Infrared Reflow:

Temperature: 260°C

Time: 30sec Max.

Recommend reflow profile

2. Wave Soldering:

Reservoir Temperature: 260°C Time in Reservoir: 10sec Max.

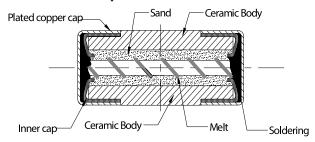
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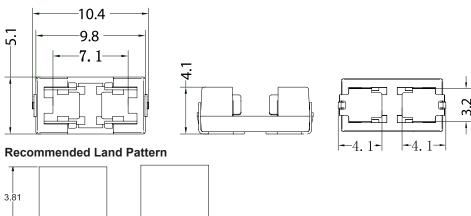
Profile Featu	ıre	Pb-Free Assembly	
Average Rai	mp-UP Rate(Tsmax to Tp)	3°C/s Max.	
Preheat	Temperature Min (Ts min)	150°C	
	Temperature Max (Ts max)	200°C	
	Time (Tsmin to Ts max)	60sec to 120sec	
Liquidous te Time at liqui	mperature(TL) dous(tL)	217°C 60 to 150S	
Peak packaç	ge body temperature (Tp)	260°C	
\ /	hin 5°C of the specified n temperature (Tc)	30S	
Average ram	np-down rate (Tp to Tsmax)	6°C/s Max.	
Time (25°C	to Peak Temperature)	8 Minutes Max.	

Mechanical Specifications



Diagram

With Clip/Holder



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2.13 REF.

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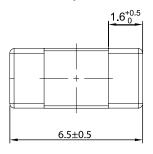


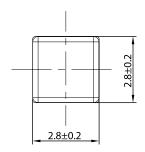
Dimensions: Millimetres



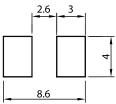
Diagram

Without Clip/Holder

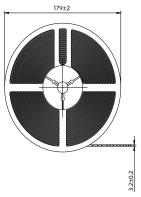


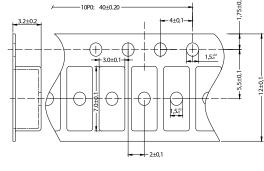


Recommended Land Pattern



Packing Information





Part Number Table

Description	Part Number	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 0.25A	MCCFB2410TFF/250	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 0.315A	MCCFB2410TFF/315	
SMD Fuse with Clip/Holder, 2410, Fast Blow, 0.375A	MCCFB2410TFF/C/375	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 0.5A	MCCFB2410TFF/500	
SMD Fuse with Clip/Holder, 2410, Fast Blow, 0.5A	MCCFB2410TFF/C/500	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 0.75A	MCCFB2410TFF/750	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 0.8A	MCCFB2410TFF/800	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 1A	MCCFB2410TFF/1	
SMD Fuse with Clip/Holder, 2410, Fast Blow, 1A	MCCFB2410TFF/C/1	
SMD Fuse with Clip/Holder, 2410, Fast Blow, 1.5A	MCCFB2410TFF/C/1.5	
SMD Fuse without Clip/Holder, 2410, Fast Blow, 1.5A	MCCFB2410TFF/1.5	

Dimensions : Millimetres

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